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L1 22823 LATEX AND (MICROPART? OR MICROCAPSULE# OR MICROENCAPSULAT? OR MICROSPHERE? OR NANOPART? OR NANOCAPSULE# OR NANOSPHERE# OR NANOPART?)

=> s 11 and antimicrobial?  
L2 1363 L1 AND ANTIMICROBIAL?

=> s 12 and (release layer)  
L3 13 L2 AND (RELEASE LAYER)

=> s 13 and silver and zeolite  
L4 0 L3 AND SILVER AND ZEOLITE

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=> s 12 and silver and zeolite
L5          42 L2 AND SILVER AND ZEOLITE

=> s 15 and polymer
L6          41 L5 AND POLYMER

=> s 16 and (medical) and (article or device)
L7          16 L6 AND (MEDICAL) AND (ARTICLE OR DEVICE)
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=> d 1 7 1-16 ibib abs
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'D' IS NOT A VALID FORMAT
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REENTER DISPLAY FORMAT FOR ALL FILES (FILEDEFAULT):.
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```
L7  ANSWER 7 OF 16  USPATFULL on STN
AN  2005:92457  USPATFULL
TI  Medical device with low magnetic susceptibility
IN  Wang, Xingwu, Wellsville, NY, UNITED STATES
     Greenwald, Howard J., Rochester, NY, UNITED STATES
     Gunderman, Robert D., Honeyoye Falls, NY, UNITED STATES
PI  US 2005079132      A1  20050414
AI  US 2004-914691      A1  20040809 (10)
RLI  Continuation-in-part of Ser. No. US 2004-887521, filed on 7 Jul 2004,
     PENDING Continuation-in-part of Ser. No. US 2004-867517, filed on 14 Jun
     2004, PENDING Continuation-in-part of Ser. No. US 2004-810916, filed on
     26 Mar 2004, GRANTED, Pat. No. US 6846985 Continuation-in-part of Ser.
     No. US 2004-808618, filed on 24 Mar 2004, PENDING Continuation-in-part
     of Ser. No. US 2004-786198, filed on 25 Feb 2004, PENDING
     Continuation-in-part of Ser. No. US 2004-780045, filed on 17 Feb 2004,
     PENDING Continuation-in-part of Ser. No. US 2003-747472, filed on 29 Dec
     2003, PENDING Continuation-in-part of Ser. No. US 2003-744543, filed on
     22 Dec 2003, PENDING Continuation-in-part of Ser. No. US 2003-442420,
     filed on 21 May 2003, PENDING Continuation-in-part of Ser. No. US
     2003-409505, filed on 8 Apr 2003, GRANTED, Pat. No. US. 6815609
DT  Utility
FS  APPLICATION
LN.CNT 17912
INCL  INCLM: 424/001.110
      INCLS: 424/422.000; 424/423.000; 600/008.000
NCL   NCLM: 424/001.110
      NCLS: 424/422.000; 424/423.000; 600/008.000
IC   [7]
      ICM  A61K051-00
      ICS  A61M036-00
      IPCI A61K0051-00 [ICM,7]; A61M0036-00 [ICS,7]
      IPCR H02J0007-00 [I,C*]; H02J0007-00 [I,A]
```

```
L7  ANSWER 1 OF 16  USPATFULL on STN
AN  2007:147166  USPATFULL
TI  Aqueous polymer dispersions for stabilizing actives
IN  Lau, Willie, Lower Gwynedd, PA, UNITED STATES
     Sheng, Miao-Hsun Li, Lower Gwynedd, PA, UNITED STATES
     Solomon, Robert D., Souderton, PA, UNITED STATES
PI  US 2007128260      A1  20070607
```

AI US 2006-605150 A1 20061128 (11)  
PRAI US 2005-741323P 20051201 (60)  
DT Utility  
FS APPLICATION  
LN.CNT 893  
INCL INCLM: 424/448.000  
NCL NCLM: 424/448.000  
IC IPCI A61F0013-02 [I,A]; A61L0015-16 [I,A]

L7 ANSWER 2 OF 16 USPATFULL on STN  
AN 2007:12286 USPATFULL  
TI Medical device with low magnetic susceptibility  
IN Wang, Xingwu, Wellsville, NY, UNITED STATES  
Greenwald, Howard J., Rochester, NY, UNITED STATES  
PI US 2007010702 A1 20070111  
AI US 2005-171761 A1 20050630 (11)  
RLI Continuation-in-part of Ser. No. US 2004-887521, filed on 7 Jul 2004,  
PENDING Continuation-in-part of Ser. No. US 2004-867517, filed on 14 Jun  
2004, PENDING Continuation-in-part of Ser. No. US 2004-810916, filed on  
26 Mar 2004, GRANTED, Pat. No. US 6846985 Continuation-in-part of Ser.  
No. US 2004-808618, filed on 24 Mar 2004, PENDING Continuation-in-part  
of Ser. No. US 2004-786198, filed on 25 Feb 2004, PENDING  
Continuation-in-part of Ser. No. US 2004-780045, filed on 17 Feb 2004,  
GRANTED, Pat. No. US 7091412 Continuation-in-part of Ser. No. US  
2003-747472, filed on 29 Dec 2003, PENDING Continuation-in-part of Ser.  
No. US 2003-744543, filed on 22 Dec 2003, ABANDONED Continuation-in-part  
of Ser. No. US 2003-442420, filed on 21 May 2003, GRANTED, Pat. No. US  
6914412 Continuation-in-part of Ser. No. US 2003-409505, filed on 8 Apr  
2003, GRANTED, Pat. No. US 6815609  
DT Utility  
FS APPLICATION  
LN.CNT 18747  
INCL INCLM: 600/008.000  
INCLS: 424/422.000  
NCL NCLM: 600/008.000  
NCLS: 424/422.000  
IC IPCI A61M0036-00 [I,A]; A61N0005-00 [I,A]; A61F0013-00 [I,A]

L7 ANSWER 3 OF 16 USPATFULL on STN  
AN 2006:322294 USPATFULL  
TI Methods and compositions for increasing the efficacy of  
biologically-active ingredients  
IN Windsor, J. Brian, Austin, TX, UNITED STATES  
Roux, Stan J., Austin, TX, UNITED STATES  
Lloyd, Alan M., Austin, TX, UNITED STATES  
Thomas, Collin E., Dallas, TX, UNITED STATES  
PI US 2006276339 A1 20061207  
AI US 2003-531744 A1 20031016 (10)  
WO 2003-US32667 20031016  
20060123 PCT 371 date  
PRAI US 2002-418803P 20021016 (60)  
DT Utility  
FS APPLICATION  
LN.CNT 14273  
INCL INCLM: 504/127.000  
INCLS: 504/128.000; 514/192.000; 514/200.000; 514/370.000; 514/602.000;  
514/414.000; 514/617.000; 514/615.000; 514/532.000; 514/616.000;  
514/535.000; 514/457.000; 514/443.000; 514/369.000; 514/533.000;  
514/512.000  
NCL NCLM: 504/127.000  
NCLS: 504/128.000; 514/192.000; 514/200.000; 514/369.000; 514/370.000;  
514/414.000; 514/443.000; 514/457.000; 514/512.000; 514/532.000;  
514/533.000; 514/535.000; 514/602.000; 514/615.000; 514/616.000;  
514/617.000

IC IPCI A01N0057-00 [I,A]; A61K0031-43 [I,A]; A61K0031-429 [I,C\*];  
A61K0031-545 [I,A]; A61K0031-425 [I,A]; A61K0031-405 [I,A];  
A61K0031-403 [I,C\*]; A61K0031-165 [I,A]; A01N0043-16 [I,A];  
A01N0043-02 [I,C\*]; A01N0047-06 [I,A]; A01N0047-02 [I,C\*];  
A61K0031-235 [I,A]; A61K0031-24 [I,A]; A61K0031-21 [I,C\*];  
A61K0031-18 [I,A]; A61K0031-426 [I,A]

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L7 ANSWER 4 OF 16 USPATFULL on STN  
AN 2005:318122 USPATFULL  
TI Iron sequestering antimicrobial composition  
IN Bringley, Joseph F., Rochester, NY, UNITED STATES  
Lerat, Yannick J., Mellecey, FRANCE  
PI US 2005276862 A1 20051215  
AI US 2004-868626 A1 20040615 (10)  
DT Utility  
FS APPLICATION  
LN.CNT 962  
INCL INCLM: 424/490.000  
NCL NCLM: 424/490.000  
IC [7]  
ICM A61K009-16  
IPCI A61K0009-16 [ICM,7]  
IPCR A61K0009-16 [I,C\*]; A61K0009-16 [I,A]

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L7 ANSWER 5 OF 16 USPATFULL on STN  
AN 2005:134837 USPATFULL  
TI Absorbent articles comprising nanoparticles  
IN Disalvo, Anthony L., Bernardsville, NJ, UNITED STATES  
Mordas, Carolyn J., Princeton, NJ, UNITED STATES  
PI US 2005115462 A1 20050602  
AI US 2004-979364 A1 20041101 (10)  
PRAI US 2003-515758P 20031030 (60)  
DT Utility  
FS APPLICATION  
LN.CNT 1517  
INCL INCLM: 106/403.000  
INCLS: 427/372.200; 106/404.000; 502/400.000  
NCL NCLM: 106/403.000  
NCLS: 106/404.000; 427/372.200; 502/400.000  
IC [7]  
ICM B05D007-00  
ICS B05D003-02; B01J020-00; C09C001-62  
IPCI B05D0007-00 [ICM,7]; B05D0003-02 [ICS,7]; B01J0020-00 [ICS,7];  
C09C0001-62 [ICS,7]  
IPCR A61L0015-16 [I,C\*]; A61L0015-18 [I,A]; B01J0020-00 [I,C\*];  
B01J0020-00 [I,A]; B05D0003-02 [I,C\*]; B05D0003-02 [I,A];  
B05D0007-00 [I,C\*]; B05D0007-00 [I,A]; C09C0001-62 [I,C\*];  
C09C0001-62 [I,A]

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L7 ANSWER 6 OF 16 USPATFULL on STN  
AN 2005:125479 USPATFULL  
TI Medical device with multiple coating layers  
IN Wang, Xingwu, Wellsville, NY, UNITED STATES  
Greenwald, Howard J., Rochester, NY, UNITED STATES  
PI US 2005107870 A1 20050519  
AI US 2004-923579 A1 20040820 (10)  
RLI Continuation-in-part of Ser. No. US 2004-914691, filed on 9 Aug 2004,  
PENDING Continuation-in-part of Ser. No. US 2004-887521, filed on 7 Jul  
2004, PENDING Continuation-in-part of Ser. No. US 2004-867517, filed on  
14 Jun 2004, PENDING Continuation-in-part of Ser. No. US 2004-810916,  
filed on 26 Mar 2004, GRANTED, Pat. No. US 6846985 Continuation-in-part

of Ser. No. US 2004-808618, filed on 24 Mar 2004, PENDING  
Continuation-in-part of Ser. No. US 2004-786198, filed on 25 Feb 2004,  
PENDING Continuation-in-part of Ser. No. US 2004-780045, filed on 17 Feb  
2004, PENDING Continuation-in-part of Ser. No. US 2003-747472, filed on  
29 Dec 2003, PENDING Continuation-in-part of Ser. No. US 2003-744543,  
filed on 22 Dec 2003, PENDING Continuation-in-part of Ser. No. US  
2003-442420, filed on 21 May 2003, PENDING Continuation-in-part of Ser.  
No. US 2003-409505, filed on 8 Apr 2003, GRANTED, Pat. No. US 6815609

DT Utility

FS APPLICATION

LN.CNT 18628

INCL INCLM: 623/001.440

NCL NCLM: 623/001.440

IC [7]

ICM A61F002-06

IPCI A61F0002-06 [ICM,7]

IPCR H02J0007-00 [I,C\*]; H02J0007-00 [I,A]

L7 ANSWER 7 OF 16 USPATFULL on STN

AN 2005:92457 USPATFULL

TI Medical device with low magnetic susceptibility

IN Wang, Xingwu, Wellsville, NY, UNITED STATES

Greenwald, Howard J., Rochester, NY, UNITED STATES

Gunderman, Robert D., Honeyoye Falls, NY, UNITED STATES

PI US 2005079132 A1 20050414

AI US 2004-914691 A1 20040809 (10)

RLI Continuation-in-part of Ser. No. US 2004-887521, filed on 7 Jul 2004,  
PENDING Continuation-in-part of Ser. No. US 2004-867517, filed on 14 Jun  
2004, PENDING Continuation-in-part of Ser. No. US 2004-810916, filed on  
26 Mar 2004, GRANTED, Pat. No. US 6846985 Continuation-in-part of Ser.  
No. US 2004-808618, filed on 24 Mar 2004, PENDING Continuation-in-part  
of Ser. No. US 2004-786198, filed on 25 Feb 2004, PENDING  
Continuation-in-part of Ser. No. US 2004-780045, filed on 17 Feb 2004,  
PENDING Continuation-in-part of Ser. No. US 2003-747472, filed on 29 Dec  
2003, PENDING Continuation-in-part of Ser. No. US 2003-744543, filed on  
22 Dec 2003, PENDING Continuation-in-part of Ser. No. US 2003-442420,  
filed on 21 May 2003, PENDING Continuation-in-part of Ser. No. US  
2003-409505, filed on 8 Apr 2003, GRANTED, Pat. No. US 6815609

DT Utility

FS APPLICATION

LN.CNT 17912

INCL INCLM: 424/001.110

INCLS: 424/422.000; 424/423.000; 600/008.000

NCL NCLM: 424/001.110

NCLS: 424/422.000; 424/423.000; 600/008.000

IC [7]

ICM A61K051-00

ICS A61M036-00

IPCI A61K0051-00 [ICM,7]; A61M0036-00 [ICS,7]

IPCR H02J0007-00 [I,C\*]; H02J0007-00 [I,A]

L7 ANSWER 8 OF 16 USPATFULL on STN

AN 2005:30370 USPATFULL

TI Latex medical articles for release of  
antimicrobial agents

IN Tan, Sharon Mi Lyn, Brighton, MA, UNITED STATES

PI US 2005025800 A1 20050203

AI US 2003-631871 A1 20030731 (10)

DT Utility

FS APPLICATION

LN.CNT 326

INCL INCLM: 424/423.000

INCLS: 604/096.010

NCL NCLM: 424/423.000

IC NCLS: 604/096.010  
[7]  
ICM A61M029-00  
ICS A61K035-60; A61F002-00  
IPCI A61M0029-00 [ICM,7]; A61K0035-60 [ICS,7]; A61K0035-56 [ICS,7,C\*];  
A61F0002-00 [ICS,7]  
IPCR A61L0029-00 [I,C\*]; A61L0029-04 [I,A]; A61L0029-16 [I,A];  
A61L0031-04 [I,C\*]; A61L0031-04 [I,A]; A61L0031-14 [I,C\*];  
A61L0031-16 [I,A]

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L7 ANSWER 9 OF 16 USPATFULL on STN  
AN 2005:30367 USPATFULL  
TI Medical device with low magnetic susceptibility  
IN Wang, Xingwu, Wellsville, NY, UNITED STATES  
Greenwald, Howard Jay, Rochester, NY, UNITED STATES  
PI US 2005025797 A1 20050203  
AI US 2004-887521 A1 20040707 (10)  
RLI Continuation-in-part of Ser. No. US 2004-867517, filed on 14 Jun 2004,  
PENDING Continuation-in-part of Ser. No. US 2004-810916, filed on 26 Mar  
2004, PENDING Continuation-in-part of Ser. No. US 2004-808618, filed on  
24 Mar 2004, PENDING Continuation-in-part of Ser. No. US 2004-786198,  
filed on 25 Feb 2004, PENDING Continuation-in-part of Ser. No. US  
2004-780045, filed on 17 Feb 2004, PENDING Continuation-in-part of Ser.  
No. US 2003-747472, filed on 29 Dec 2003, PENDING Continuation-in-part  
of Ser. No. US 2003-744543, filed on 22 Dec 2003, PENDING  
Continuation-in-part of Ser. No. US 2003-442420, filed on 21 May 2003,  
PENDING Continuation-in-part of Ser. No. US 2003-409505, filed on 8 Apr  
2003, GRANTED, Pat. No. US 6815609  
DT Utility  
FS APPLICATION  
LN.CNT 17461  
INCL INCLM: 424/422.000  
INCLS: 424/423.000; 424/489.000  
NCL NCLM: 424/422.000  
NCLS: 424/423.000; 424/489.000  
IC [7]  
ICM A61K009-14  
IPCI A61K0009-14 [ICM,7]  
IPCR H02J0007-00 [I,C\*]; H02J0007-00 [I,A]

L7 ANSWER 10 OF 16 USPATFULL on STN  
AN 2004:321764 USPATFULL  
TI Therapeutic assembly  
IN Wang, Xingwu, Wellsville, NY, UNITED STATES  
Greenwald, Howard J., Rochester, NY, UNITED STATES  
Lanzafame, John, Victor, NY, UNITED STATES  
Weiner, Michael L., Webster, NY, UNITED STATES  
Connelly, Patrick R., Rochester, NY, UNITED STATES  
PI US 2004254419 A1 20041216  
AI US 2004-867517 A1 20040614 (10)  
RLI Continuation-in-part of Ser. No. US 2004-810916, filed on 26 Mar 2004,  
PENDING Continuation-in-part of Ser. No. US 2004-808618, filed on 24 Mar  
2004, PENDING Continuation-in-part of Ser. No. US 2004-786198, filed on  
25 Feb 2004, PENDING Continuation-in-part of Ser. No. US 2004-780045,  
filed on 17 Feb 2004, PENDING Continuation-in-part of Ser. No. US  
2003-747472, filed on 29 Dec 2003, PENDING Continuation-in-part of Ser.  
No. US 2003-744543, filed on 22 Dec 2003, PENDING Continuation-in-part  
of Ser. No. US 2003-409505, filed on 8 Apr 2003, PENDING  
Continuation-in-part of Ser. No. US 2003-442420, filed on 21 May 2003,  
PENDING  
DT Utility  
FS APPLICATION  
LN.CNT 16208

INCL INCLM: 600/008.000  
INCLS: 424/001.110; 424/422.000  
NCL NCLM: 600/008.000  
NCLS: 424/001.110; 424/422.000  
IC [7]  
ICM A61M036-00  
ICS A61K051-00  
IPCI A61M0036-00 [ICM,7]; A61K0051-00 [ICS,7]  
IPCR A61N0002-00 [I,C\*]; A61N0002-10 [I,A]; H02J0007-00 [I,C\*];  
H02J0007-00 [I,A]

L7 ANSWER 11 OF 16 USPATFULL on STN  
AN 2004:293096 USPATFULL  
TI Treatment catheters with thermally insulated regions  
IN Cioanta, Iulian, Cary, NC, UNITED STATES  
Klein, Richard Barry, Cary, NC, UNITED STATES  
Lazarovitz, Jacob, Hod Hasharon, ISRAEL  
PI US 2004230188 A1 20041118  
AI US 2003-436803 A1 20030512 (10)  
DT Utility  
FS APPLICATION  
LN.CNT 2137  
INCL INCLM: 606/034.000  
NCL NCLM: 606/034.000  
IC [7]  
ICM A61B018-04  
IPCI A61B0018-04 [ICM,7]  
IPCR A61B0017-00 [N,C\*]; A61B0017-00 [N,A]; A61B0018-04 [I,C\*];  
A61B0018-04 [I,A]

L7 ANSWER 12 OF 16 USPATFULL on STN  
AN 2003:334729 USPATFULL  
TI Antimicrobial body covering articles  
IN Lelah, Michael D., Arlington Heights, IL, UNITED STATES  
Kampa, Joel J., Lakehills, TX, UNITED STATES  
Barenberg, Sumner A., Chicago, IL, UNITED STATES  
PA Bernard Technologies, Inc. (U.S. corporation)  
PI US 2003235605 A1 20031225  
AI US 2003-338923 A1 20030108 (10)  
PRAI US 2002-346591P 20020108 (60)  
DT Utility  
FS APPLICATION  
LN.CNT 2089  
INCL INCLM: 424/443.000  
INCLS: 442/123.000; 424/661.000; 424/700.000; 424/718.000  
NCL NCLM: 424/443.000  
NCLS: 424/661.000; 424/700.000; 424/718.000; 442/123.000  
IC [7]  
ICM A61K009-70  
ICS A61K033-14; A61K033-00; B32B027-04; B32B027-12; B32B005-02  
IPCI A61K0009-70 [ICM,7]; A61K0033-14 [ICS,7]; A61K0033-00 [ICS,7];  
B32B0027-04 [ICS,7]; B32B0027-12 [ICS,7]; B32B0005-02 [ICS,7]  
IPCR A01N0025-06 [I,C\*]; A01N0025-06 [I,A]; A41D [I,S]; A41D0001-00  
[I,C\*]; A41D0001-00 [I,A]; A61K0009-70 [I,C\*]; A61K0009-70 [I,A];  
A61K0033-00 [I,C\*]; A61K0033-00 [I,A]; A61K0033-14 [I,C\*];  
A61K0033-14 [I,A]; B32B0005-02 [I,C\*]; B32B0005-02 [I,A];  
B32B0027-04 [I,C\*]; B32B0027-04 [I,A]; B32B0027-12 [I,C\*];  
B32B0027-12 [I,A]

CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L7 ANSWER 13 OF 16 USPATFULL on STN  
AN 2002:157943 USPATFULL  
TI Treatment catheters with thermally insulated regions  
IN Cioanta, Iulian, Cary, NC, UNITED STATES

Klein, Richard Barry, Cary, NC, UNITED STATES  
 Lazarovitz, Jacob, Hod Hasharon, ISRAEL  
 PI US 2002082556 A1 20020627  
 US 6758857 B2 20040706  
 AI US 2001-11700 A1 20011113 (10)  
 PRAI US 2000-248109P 20001113 (60)  
 DT Utility  
 FS APPLICATION  
 LN.CNT 2276  
 INCL INCLM: 604/113.000  
 INCLS: 604/096.010; 607/104.000  
 NCL NCLM: 607/105.000; 604/113.000  
 NCLS: 604/043.000; 604/101.010; 604/113.000; 604/523.000; 604/544.000;  
 604/919.000; 606/027.000; 606/192.000; 607/099.000; 607/113.000;  
 604/096.010; 607/104.000  
 IC [7]  
 ICM A61F007-12  
 ICS H05B001-00  
 IPCI A61F0007-12 [ICM,7]; H05B0001-00 [ICS,7]  
 IPCI-2 A61F0007-00 [ICM,7]  
 IPCR A61B0017-00 [N,C\*]; A61B0017-00 [N,A]; A61B0017-22 [N,C\*];  
 A61B0017-22 [N,A]; A61B0018-04 [I,C\*]; A61B0018-04 [I,A];  
 A61F0007-12 [N,C\*]; A61F0007-12 [N,A]; A61M0031-00 [N,C\*];  
 A61M0031-00 [N,A]  
 L7 ANSWER 14 OF 16 USPATFULL on STN  
 AN 96:20959 USPATFULL  
 TI Polyethylene glycol as a binder material for fibers  
 IN Hansen, Michael R., Seattle, WA, United States  
 Park, David W., Puyallup, WA, United States  
 PA Weyerhaeuser Company, Tacoma, WA, United States (U.S. corporation)  
 PI US 5498478 19960312  
 AI US 1994-210114 19940317 (8)  
 RLI Continuation of Ser. No. US 1992-919156, filed on 22 Jul 1992, now  
 abandoned which is a continuation-in-part of Ser. No. US 1989-326188,  
 filed on 20 Mar 1989, now patented, Pat. No. US 5230959 Ser. No. Ser.  
 No. US 1989-326181, filed on 20 Mar 1989, now abandoned And Ser. No. US  
 1989-326196, filed on 20 Mar 1989, now abandoned And a continuation of  
 Ser. No. US 1991-673899, filed on 22 Mar 1991  
 DT Utility  
 FS Granted  
 LN.CNT 2565  
 INCL INCLM: 428/372.000  
 INCLS: 428/243.000; 428/281.000; 428/283.000; 428/357.000; 428/259.000;  
 428/375.000; 428/393.000  
 NCL NCLM: 428/372.000  
 NCLS: 428/357.000; 428/359.000; 428/375.000; 428/393.000; 442/417.000  
 IC [6]  
 ICM D02G003-00  
 IPCI D02G0003-00 [ICM,6]  
 IPCR A61F0013-15 [I,C\*]; A61F0013-15 [I,A]; A61L0015-16 [I,C\*];  
 A61L0015-46 [I,A]; D04H0001-42 [I,C\*]; D04H0001-42 [I,A];  
 D04H0001-54 [I,C\*]; D04H0001-54 [I,A]; D06M0011-00 [I,C\*];  
 D06M0011-46 [I,A]; D06M0011-74 [I,A]; D21H0017-00 [I,C\*];  
 D21H0017-48 [I,A]  
 EXF 428/372; 428/378; 428/357; 428/359; 428/373; 428/374; 428/393; 428/375  
 L7 ANSWER 15 OF 16 USPATFULL on STN  
 AN 95:62554 USPATFULL  
 TI Binder coated discontinuous fibers with adhered particulate materials  
 IN Young, Sr., Richard H., Federal Way, WA, United States  
 Neogi, Amar N., Seattle, WA, United States  
 Hansen, Michael R., Seattle, WA, United States  
 Hodgson, Kevin T., Seattle, WA, United States

Halabisky, Donald D., Tacoma, WA, United States  
 Marsh, David G., Federal Way, WA, United States  
 Brunnenkant, Christel, Seattle, WA, United States  
 Park, David W., Puyallup, WA, United States  
 Gaddis, Paul G., Renton, WA, United States  
 Johnston, Jr., William C., Puyallup, WA, United States  
 PA Weyerhaeuser Company, Tacoma, WA, United States (U.S. corporation)  
 PI US 5432000 19950711  
 AI US 1991-673899 19910322 (7)  
 RLI Continuation-in-part of Ser. No. US 1989-326188, filed on 20 Mar 1989,  
       now patented, Pat. No. US 5230959 Ser. No. Ser. No. US 1989-326181,  
       filed on 20 Mar 1989 And Ser. No. US 1989-326196, filed on 20 Mar 1989  
 DT Utility  
 FS Granted  
 LN.CNT 2486  
 INCL INCLM: 428/372.000  
       INCLS: 428/357.000; 428/361.000; 428/373.000; 428/378.000; 428/393.000;  
       428/375.000  
 NCL NCLM: 428/372.000  
       NCLS: 428/357.000; 428/361.000; 428/373.000; 428/375.000; 428/378.000;  
       428/393.000  
 IC [6]  
       ICM D02G003-00  
       IPCI D02G0003-00 [ICM, 6]  
       IPCR A61F0013-15 [I,C\*]; A61F0013-15 [I,A]; A61L0015-16 [I,C\*];  
           A61L0015-46 [I,A]; D04H0001-42 [I,C\*]; D04H0001-42 [I,A];  
           D04H0001-54 [I,C\*]; D04H0001-54 [I,A]; D06M0011-00 [I,C\*];  
           D06M0011-46 [I,A]; D06M0011-74 [I,A]; D21H0017-00 [I,C\*];  
           D21H0017-48 [I,A]  
 EXF 428/361; 428/372; 428/373; 428/374; 428/375; 428/389; 604/288; 604/368  
 CAS INDEXING IS AVAILABLE FOR THIS PATENT.

L7 ANSWER 16 OF 16 EPFULL COPYRIGHT 2007 EPO/FIZ KA on STN  
 AN 2006:106345 EPFULL EDP 20070606 ED 20070606 UP 20070606  
       DUPD 20070606 DUPW 200723  
 TIEN Aqueous polymer dispersions for stabilizing actives.  
 TIFR Dispersions polymeres aqueuses pour stabiliser des actifs.  
 TIDE Waessige Polymerdispersionen zur Stabilisierung von Aktivstoffen.  
 IN Lau, Willie, 837 Warren Road, Lower GwyneddPennsylvania 19002, US;  
       Solomon, Robert D., 135 Roberts Road, SoudertonPennsylvania 18964, US;  
       Sheng, Miao-Hsun Li, 1002 Stonebridge Road, Lower GwyneddPennsylvania  
       19002, US  
 PA Rohm and Haas Company, 100 Independence Mall West, Philadelphia, PA  
       19106-2399, US  
 PAN 7041000  
 AG Kent, Venetia Katherine, et al, Rohm and Haas (UK) Ltd. European Patent  
       Department 4th Floor, 22 Tudor Street, London EC4Y 0AY, GB  
 AGN 78111  
 DT Patent  
 LAF English  
 LA English  
 LAP English  
 TL German; English; French  
 PIT EPA1 Application published with search report  
 PI EP 1792921 A1 20070606  
 DS AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IS IT LI LT LU LV MC NL  
       PL PT RO SE SI SK TR  
       EXTENSION STATES: AL BA HR MK YU  
 AI EP 2006-256024 A 20061124  
 PRAI US 2005-741323P P 20051201  
 IPCI C08F0020-00 [I,A]; C08F0020-60 [I,A]; C08F0022-00 [I,A]; C08F0022-38  
       [I,A]; C08F0026-00 [I,A]  
       C08F0020-00 [I,C\*]; C08F0020-00 [I,C\*]; C08F0022-00 [I,C\*]; C08F0022-00

[I,C\*]; C08F0026-00 [I,C\*]